

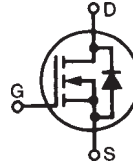
# HiPerFET™ Power MOSFETs Q-Class

N-Channel Enhancement Mode  
Avalanche Rated,  
Low  $Q_g$ , High  $dv/dt$

**IXFH23N80Q**  
**IXFT23N80Q**

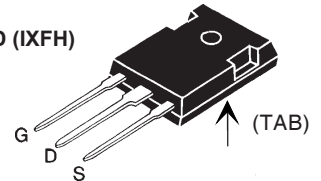
$V_{DSS} = 800 \text{ V}$   
 $I_{D25} = 23 \text{ A}$   
 $R_{DS(on)} = 0.42 \text{ } \Omega$

$t_{rr} \leq 250 \text{ ns}$

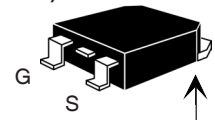


| Symbol    | Test Conditions  | Maximum Ratings |                        |
|-----------|--|-----------------|------------------------|
| $V_{DSS}$ | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$  | 800             | V                      |
| $V_{DGR}$ | $T_J = 25^\circ\text{C}$ to $150^\circ\text{C}$ ; $R_{GS} = 1 \text{ M}\Omega$   | 800             | V                      |
| $V_{GS}$  | Continuous   | $\pm 30$        | V                      |
| $V_{GSM}$ | Transient  | $\pm 40$        | V                      |
| $I_{D25}$ | $T_C = 25^\circ\text{C}$   | 23              | A                      |
| $I_{DM}$  | $T_C = 25^\circ\text{C}$ , pulse width limited by $T_{JM}$   | 92              | A                      |
| $I_{AR}$  | $T_C = 25^\circ\text{C}$   | 23              | A                      |
| $E_{AR}$  | $T_C = 25^\circ\text{C}$   | 45              | mJ                     |
| $E_{AS}$  | $T_C = 25^\circ\text{C}$   | 1.5             | J                      |
| $dv/dt$   | $I_S \leq I_{DM}$ , $di/dt \leq 100 \text{ A}/\mu\text{s}$ , $V_{DD} \leq V_{DSS}$ ,<br>$T_J \leq 150^\circ\text{C}$ , $R_G = 2 \text{ } \Omega$ | 5               | V/ns                   |
| $P_D$     | $T_C = 25^\circ\text{C}$   | 500             | W                      |
| $T_J$     |  | -55 ... +150    | $^\circ\text{C}$       |
| $T_{JM}$  |  | 150             | $^\circ\text{C}$       |
| $T_{stg}$ |  | -55 ... +150    | $^\circ\text{C}$       |
| $T_L$     | 1.6 mm (0.063 in) from case for 10 s   | 300             | $^\circ\text{C}$       |
| $M_d$     | Mounting torque  | TO-247          | 1.13/10 Nm/lb.in.      |
| $F_C$     | Mounting Force   | TO-268          | 20...120/4.5...27 N/lb |
| Weight    |  | TO-247          | 6 g                    |
|           |  | TO-268          | 4 g                    |

TO-247 AD (IXFH)



TO-268 (D3) (IXFT)



G = Gate  
S = Source

TAB = Drain

## Features

- IXYS advanced low  $Q_g$  process
- International standard packages
- Epoxy meets UL 94 V-0 flammability classification
- Low  $R_{DS(on)}$  low  $Q_g$
- Avalanche energy and current rated
- Fast intrinsic rectifier

## Advantages

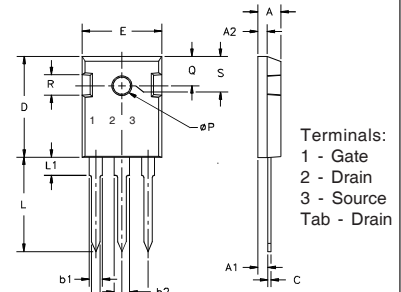
- Easy to mount
- Space savings
- High power density

| Symbol       | Test Conditions   | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |                          |
|--------------|---|---|------|--------------------------|
|              |   | min.  | typ. | max.                     |
| $V_{DSS}$    | $V_{GS} = 0 \text{ V}$ , $I_D = 250 \text{ } \mu\text{A}$   | 800   |      | V                        |
| $V_{GS(th)}$ | $V_{DS} = V_{GS}$ , $I_D = 3 \text{ mA}$  | 2.5   |      | 4.5 V                    |
| $I_{GSS}$    | $V_{GS} = \pm 30 \text{ V}_{DC}$ , $V_{DS} = 0$   |   |      | $\pm 100 \text{ nA}$     |
| $I_{DSS}$    | $V_{DS} = V_{DSS}$ , $T_J = 25^\circ\text{C}$<br>$V_{GS} = 0 \text{ V}$ , $T_J = 125^\circ\text{C}$                             |   |      | 25 $\mu\text{A}$<br>1 mA |
| $R_{DS(on)}$ | $V_{GS} = 10 \text{ V}$ , $I_D = 0.5 \cdot I_{D25}$<br>Pulse test, $t \leq 300 \text{ } \mu\text{s}$ , duty cycle $d \leq 2 \%$ |   |      | 0.42 $\Omega$            |

| Symbol       | Test Conditions  | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |      |
|--------------|--|---|------|------|
|              |  | min.  | typ. | max. |
| $g_{fs}$     | $V_{DS} = 10\text{ V}; I_D = 0.5 \cdot I_{D25}$ , pulse test   | 18  | 26   | S    |
| $C_{iss}$    | $V_{GS} = 0\text{ V}, V_{DS} = 25\text{ V}, f = 1\text{ MHz}$  |   | 4900 | pF   |
| $C_{oss}$    |  |   | 500  | pF   |
| $C_{rss}$    |  |   | 130  | pF   |
| $t_{d(on)}$  | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$<br>$R_G = 1.5\ \Omega$ (External), |   | 28   | ns   |
| $t_r$        |  |   | 27   | ns   |
| $t_{d(off)}$ |  |   | 74   | ns   |
| $t_f$        |  |   | 14   | ns   |
| $Q_{g(on)}$  | $V_{GS} = 10\text{ V}, V_{DS} = 0.5 \cdot V_{DSS}, I_D = 0.5 \cdot I_{D25}$                                    |   | 130  | nC   |
| $Q_{gs}$     |  |   | 26   | nC   |
| $Q_{gd}$     |  |   | 55   | nC   |
| $R_{thJC}$   |  |   | 0.25 | K/W  |
| $R_{thCK}$   | TO-247   |   | 0.25 | K/W  |

| Symbol   | Test Conditions   | Characteristic Values<br>( $T_J = 25^\circ\text{C}$ , unless otherwise specified) |      |               |
|----------|---|---|------|---------------|
|          |   | min.  | typ. | max.          |
| $I_S$    | $V_{GS} = 0\text{ V}$   |   |      | 23 A          |
| $I_{SM}$ | Repetitive; pulse width limited by $T_{JM}$   |   |      | 92 A          |
| $V_{SD}$ | $I_F = I_S, V_{GS} = 0\text{ V}$ ,<br>Pulse test, $t \leq 300\ \mu\text{s}$ , duty cycle $d \leq 2\%$ |   |      | 1.5 V         |
| $t_{rr}$ | $I_F = I_S - di/dt = 100\text{ A}/\mu\text{s}, V_R = 100\text{ V}$                                    |   | 1    | 250 ns        |
| $Q_{RM}$ |   |   | 9    | $\mu\text{C}$ |
| $I_{RM}$ |   |   |      | A             |

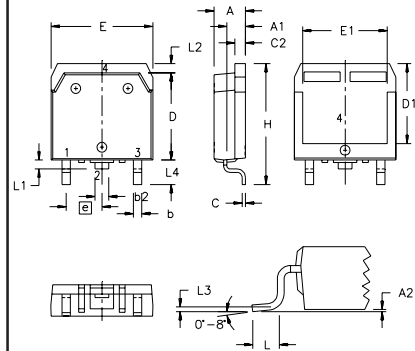
### TO-247 AD (IXFH) Outline



Terminals:  
1 - Gate  
2 - Drain  
3 - Source  
Tab - Drain

| Dim.           | Millimeter |       | Inches |       |
|----------------|------------|-------|--------|-------|
|                | Min.       | Max.  | Min.   | Max.  |
| A              | 4.7        | 5.3   | .185   | .209  |
| A <sub>1</sub> | 2.2        | 2.54  | .087   | .102  |
| A <sub>2</sub> | 2.2        | 2.6   | .059   | .098  |
| b              | 1.0        | 1.4   | .040   | .055  |
| b <sub>1</sub> | 1.65       | 2.13  | .065   | .084  |
| b <sub>2</sub> | 2.87       | 3.12  | .113   | .123  |
| C              | .4         | .8    | .016   | .031  |
| D              | 20.80      | 21.46 | .819   | .845  |
| E              | 15.75      | 16.26 | .610   | .640  |
| e              | 5.20       | 5.72  | 0.205  | 0.225 |
| L              | 19.81      | 20.32 | .780   | .800  |
| L <sub>1</sub> |            | 4.50  |        | .177  |
| ∅P             | 3.55       | 3.65  | .140   | .144  |
| Q              | 5.89       | 6.40  | 0.232  | 0.252 |
| R              | 4.32       | 5.49  | .170   | .216  |
| S              | 6.15       | BSC   | .242   | BSC   |

### TO-268 (IXFT) Outline



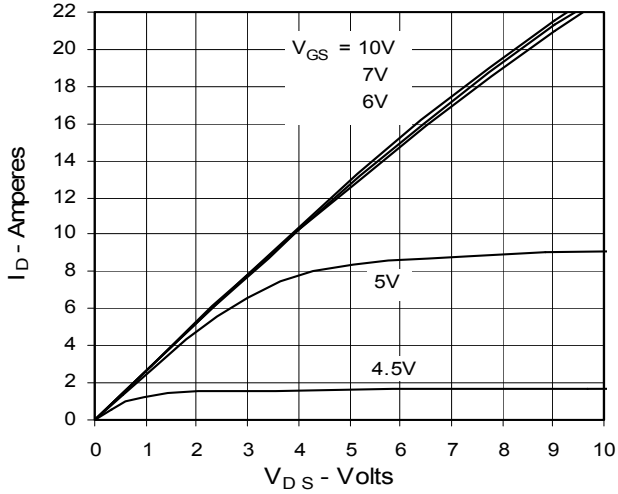
| SYM | INCHES |      | MILLIMETERS |       |
|-----|--------|------|-------------|-------|
|     | MIN    | MAX  | MIN         | MAX   |
| A   | .193   | .201 | 4.90        | 5.10  |
| A1  | .106   | .114 | 2.70        | 2.90  |
| A2  | .001   | .010 | 0.02        | 0.25  |
| b   | .045   | .057 | 1.15        | 1.45  |
| b2  | .075   | .083 | 1.90        | 2.10  |
| C   | .016   | .026 | 0.40        | 0.65  |
| C2  | .057   | .063 | 1.45        | 1.60  |
| D   | .543   | .551 | 13.80       | 14.00 |
| D1  | .488   | .500 | 12.40       | 12.70 |
| E   | .624   | .632 | 15.85       | 16.05 |
| E1  | .524   | .535 | 13.30       | 13.60 |
| e   | .215   | BSC  | 5.45        | BSC   |
| H   | .736   | .752 | 18.70       | 19.10 |
| L   | .094   | .106 | 2.40        | 2.70  |
| L1  | .047   | .055 | 1.20        | 1.40  |
| L2  | .039   | .045 | 1.00        | 1.15  |
| L3  | .010   | BSC  | 0.25        | BSC   |
| L4  | .150   | .161 | 3.80        | 4.10  |

IXYS reserves the right to change limits, test conditions, and dimensions.

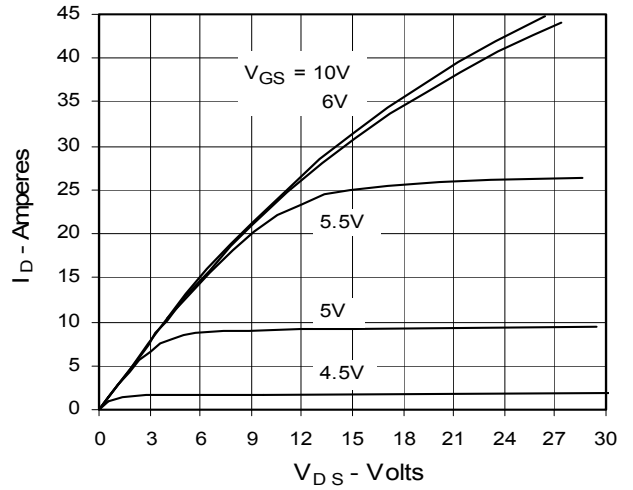
IXYS MOSFETs and IGBTs are covered by one or more of the following U.S. patents:

4,835,592 4,881,106 5,017,508 5,049,961 5,187,117 5,486,715 6,306,728B1 6,259,123B1 6,306,728B1  
4,850,072 4,931,844 5,034,796 5,063,307 5,237,481 5,381,025 6,404,065B1 6,162,665 6,534,343

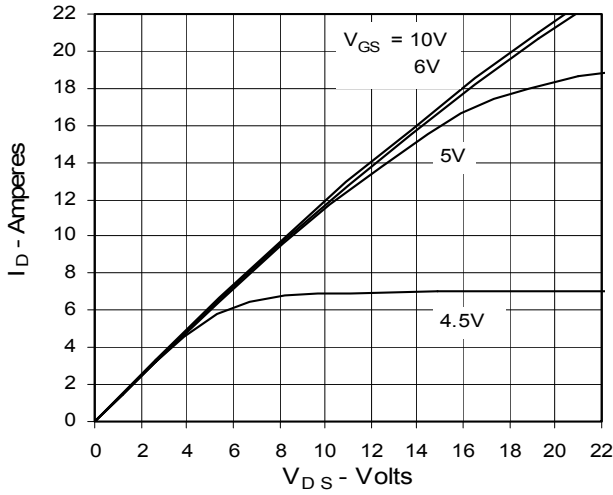
**Fig. 1. Output Characteristics @ 25°C**



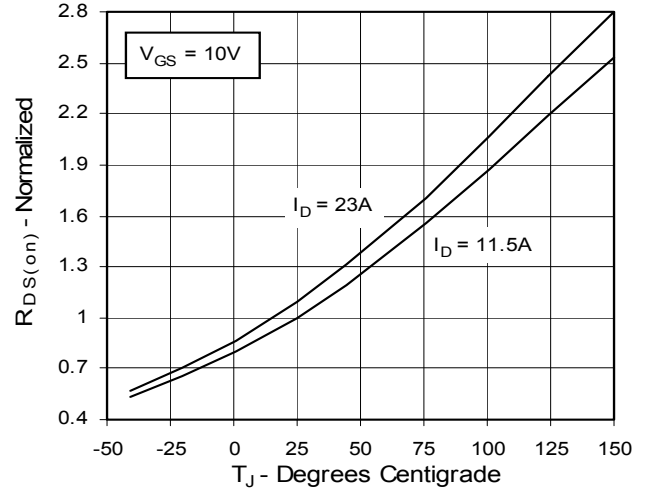
**Fig. 2. Extended Output Characteristics @ 25°C**



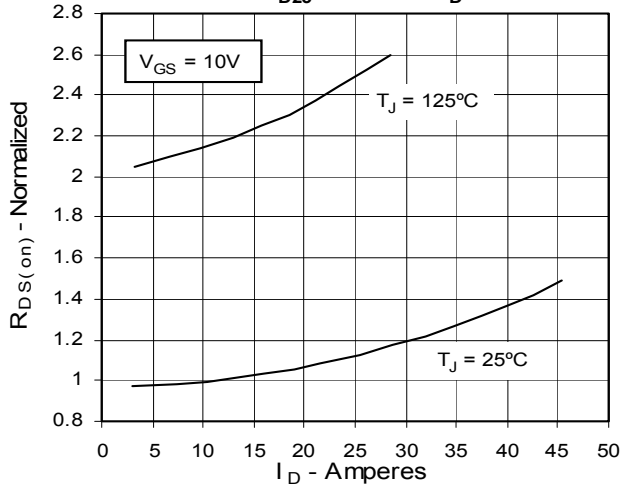
**Fig. 3. Output Characteristics @ 125°C**



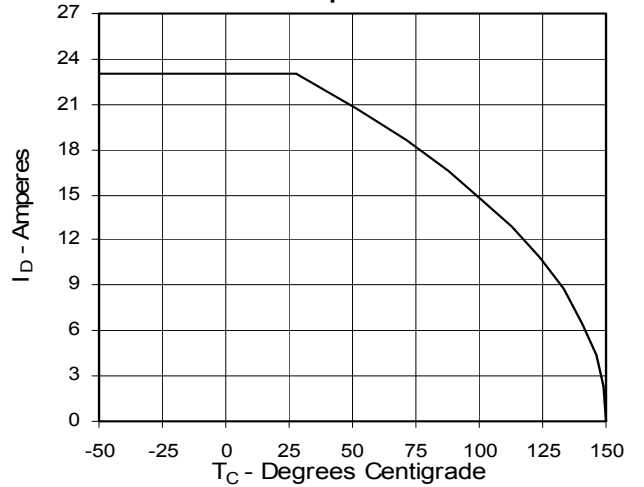
**Fig. 4.  $R_{DS(on)}$  Normalized to 0.5  $I_{D25}$  Value vs. Junction Temperature**



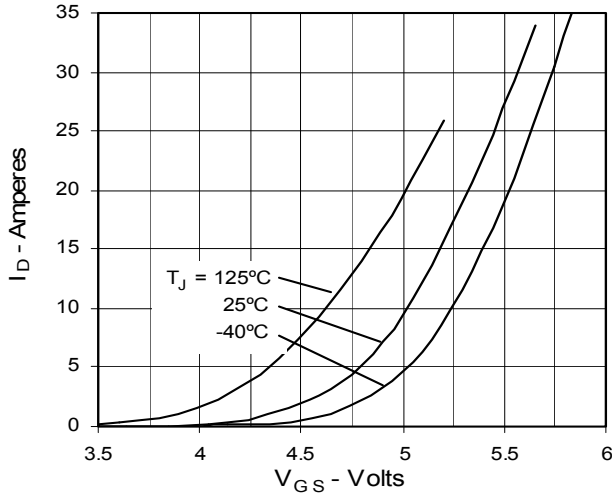
**Fig. 5.  $R_{DS(on)}$  Normalized to 0.5  $I_{D25}$  Value vs.  $I_D$**



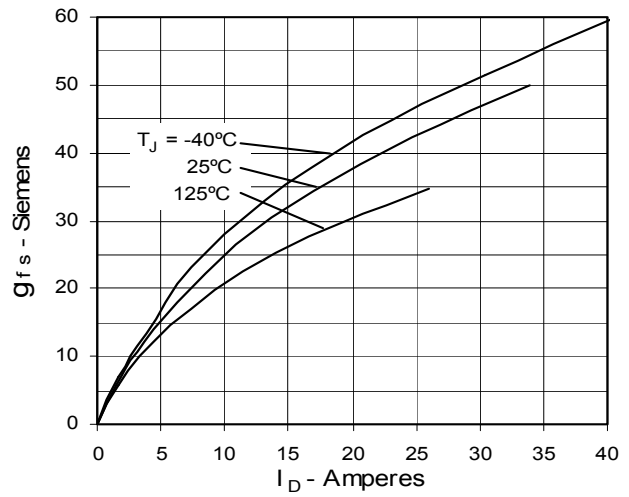
**Fig. 6. Drain Current vs. Case Temperature**



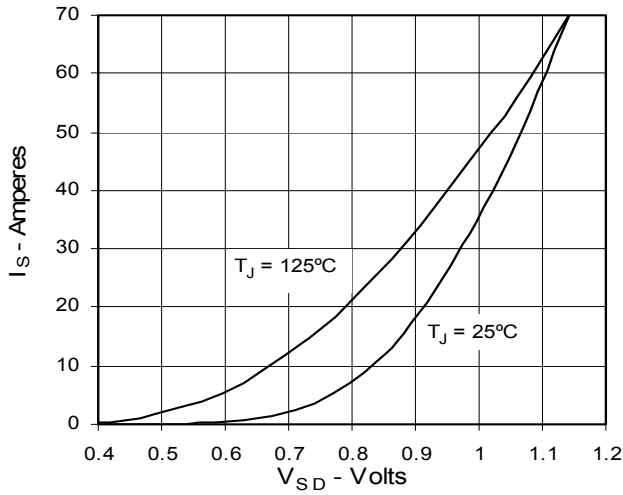
**Fig. 7. Input Admittance**



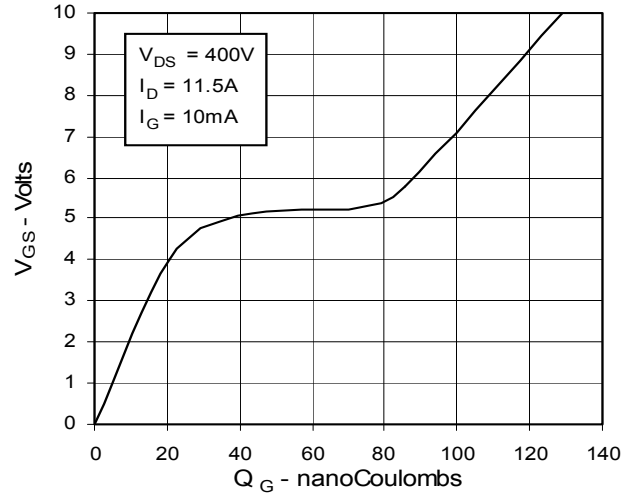
**Fig. 8. Transconductance**



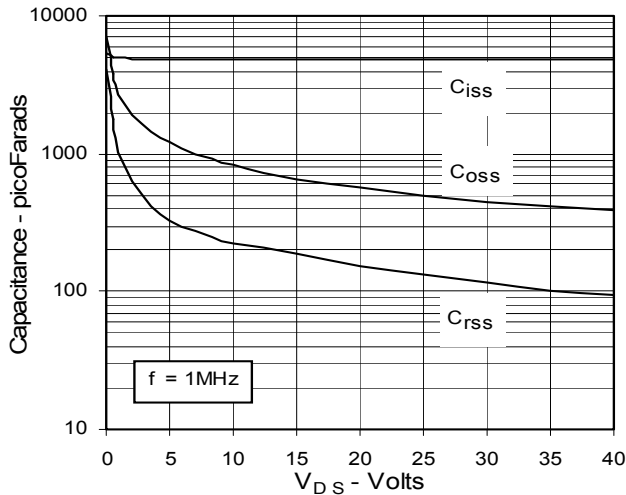
**Fig. 9. Source Current vs. Source-To-Drain Voltage**



**Fig. 10. Gate Charge**



**Fig. 11. Capacitance**

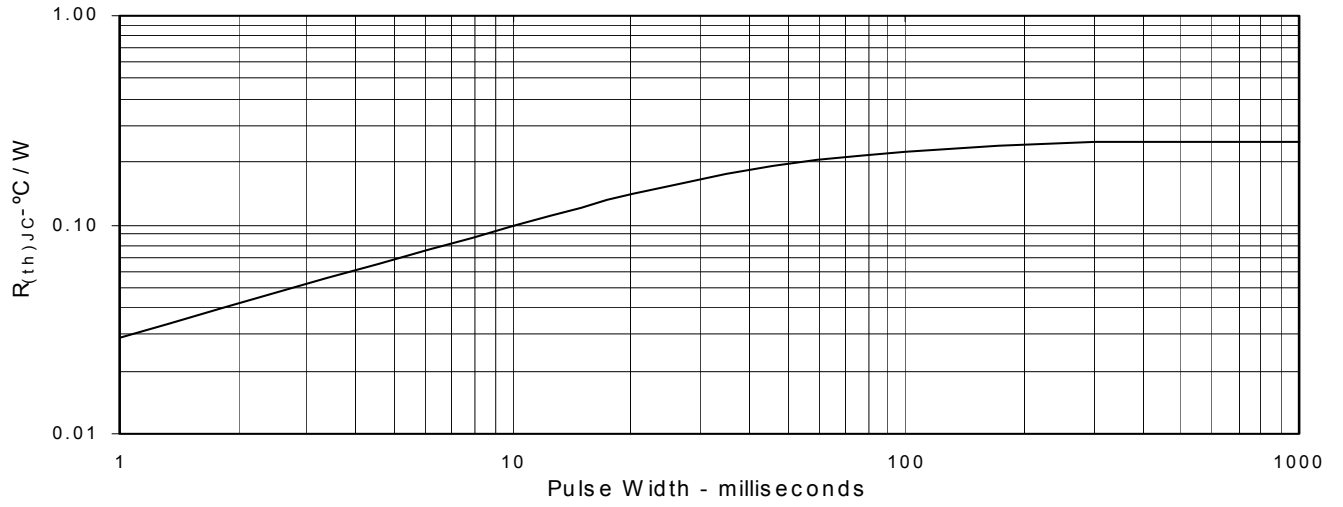


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4,850,072 4,931,844 5,034,796 5,063,307 5,237,481 5,381,025 6,404,065B1 6,162,665 6,534,343

Fig. 12. Maximum Transient Thermal Resistance





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